

2SK1155, 2SK1156

Silicon N Channel MOS FET

REJ03G0909-0200 (Previous: ADE-208-1247) Rev.2.00 Sep 07, 2005

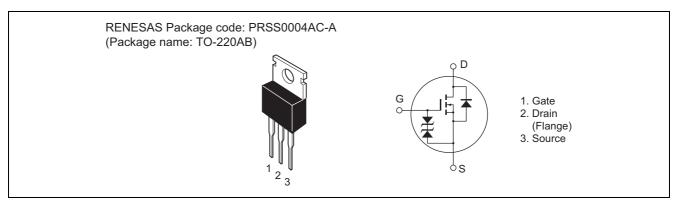
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
	Symbol	Ratings	Unit
2SK1155	V _{DSS}	450	V
2SK1156		500	
Gate to source voltage		±30	V
	ID	5	А
	I _{D(pulse)} * ¹	20	А
Body to drain diode reverse drain current		5	А
	Pch* ²	50	W
	Tch	150	°C
	Tstg	-55 to +150	°C
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Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

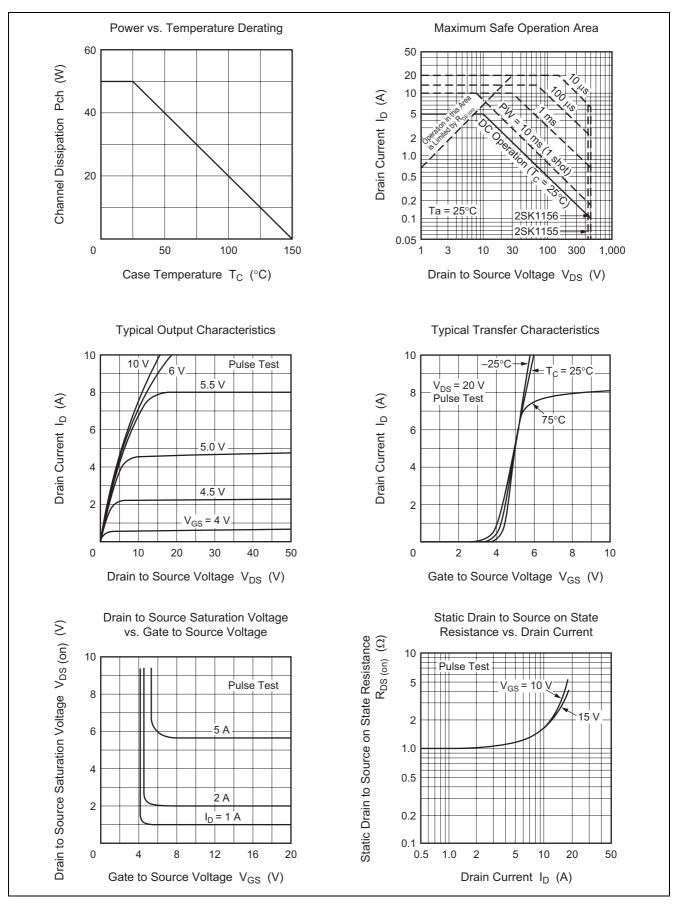
2. Value at $T_C = 25^{\circ}C$

Electrical Characteristics

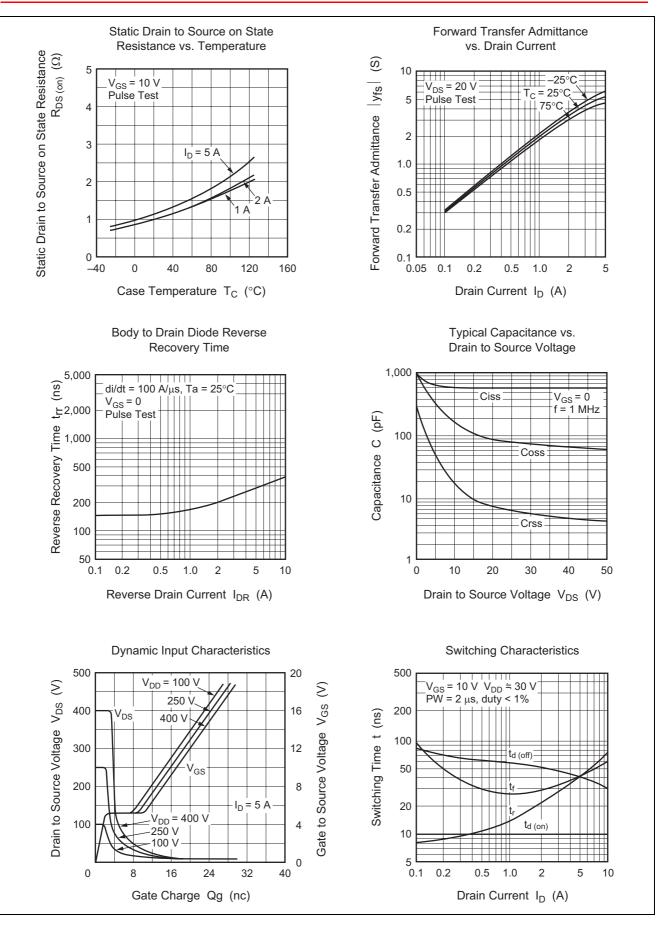
							$(Ta = 25^{\circ}C)$
ltem		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1155	V _{(BR)DSS}	450	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
breakdown voltage	2SK1156] [500				
Gate to source breakdown voltage		V _{(BR)GSS}	±30	—	—	V	$I_G = \pm 100 \ \mu A, V_{DS} = 0$
Gate to source leak current		I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain	2SK1155	I _{DSS}	_	—	250	μΑ	$V_{DS} = 360 \text{ V}, V_{GS} = 0$
current	2SK1156						$V_{DS} = 400 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage		V _{GS(off)}	2.0	_	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on	2SK1155	R _{DS(on)}	_	1.0	1.4	Ω	I_D = 2.5 A, V_{GS} = 10 V * ³
state resistance	2SK1156]	_	1.2	1.5		
Forward transfer admittance		y _{fs}	2.5	4.0	—	S	$I_D = 2.5 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance		Ciss	_	640	—	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance		Coss	_	160	—	pF	f = 1 MHz
Reverse transfer capacitance		Crss	_	20	—	pF	
Turn-on delay time		t _{d(on)}	_	10	—	ns	$I_D = 2.5 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time		tr	_	25	—	ns	R _L = 12 Ω
Turn-off delay time		t _{d(off)}	_	50	—	ns	
Fall time		t _f	_	30	—	ns	
Body to drain diode forward voltage		V _{DF}		0.95	_	V	$I_F = 5 A, V_{GS} = 0$
Body to drain diode reverse recovery		t _{rr}	_	300	—	ns	$I_F = 5 \text{ A}, V_{GS} = 0,$
time							$di_F/dt = 100 \text{ A}/\mu \text{s}$

Note: 3. Pulse test

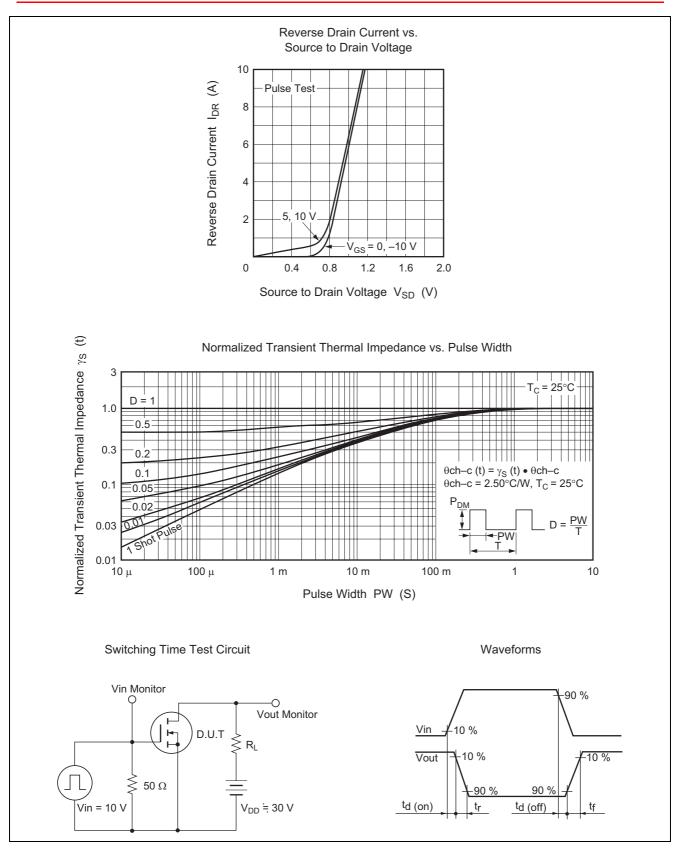
Main Characteristics



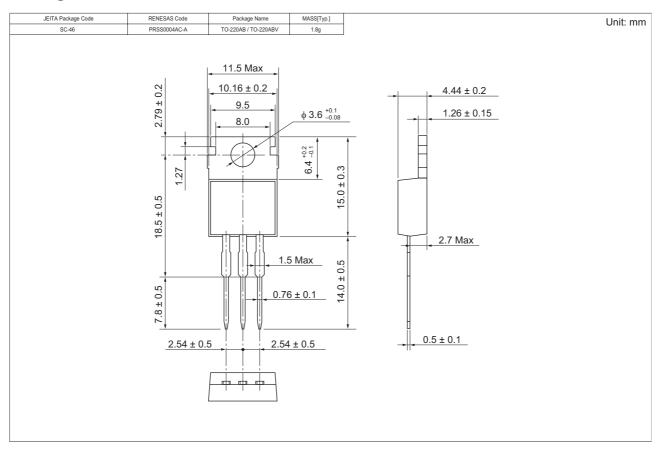








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK1155-E	500 pcs	Box (Sack)
2SK1156-E	500 pcs	Box (Sack)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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